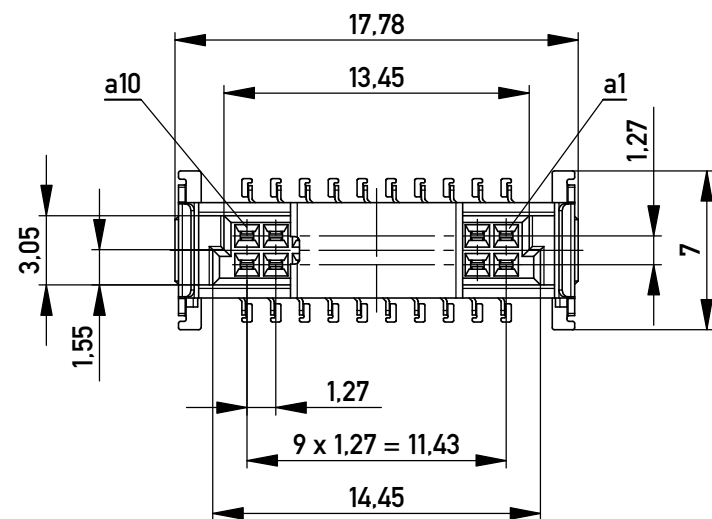
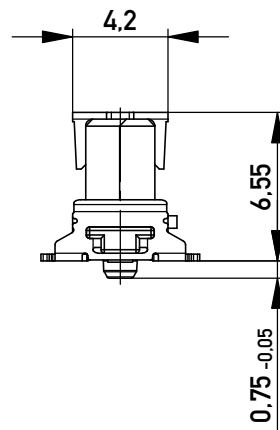
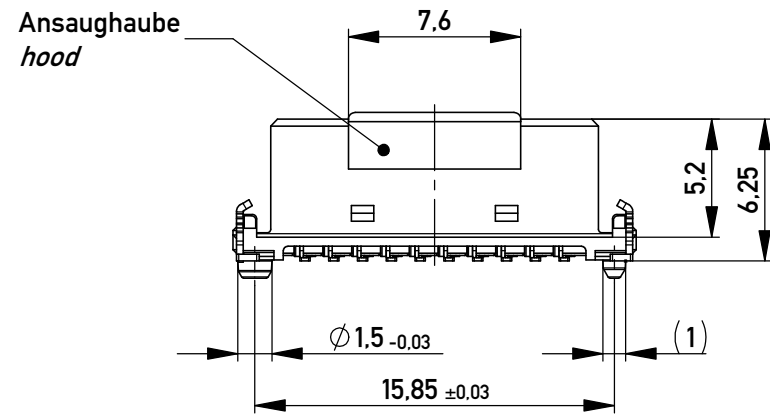
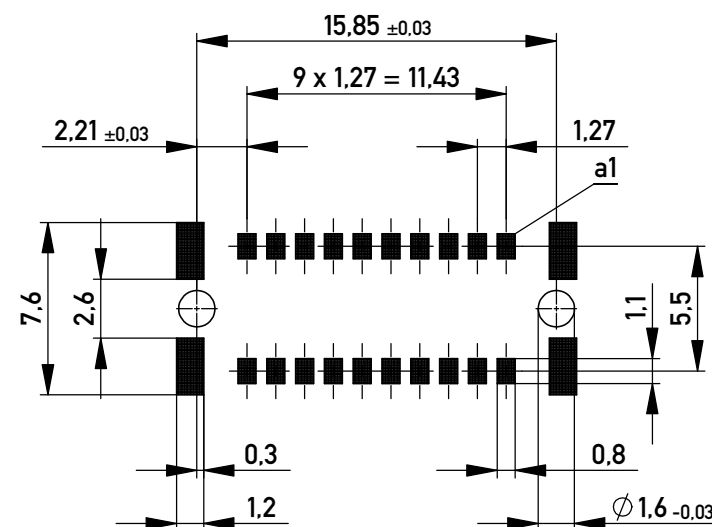


Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



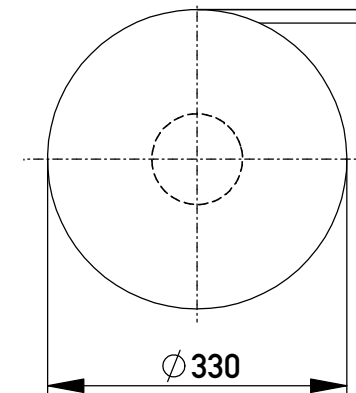
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

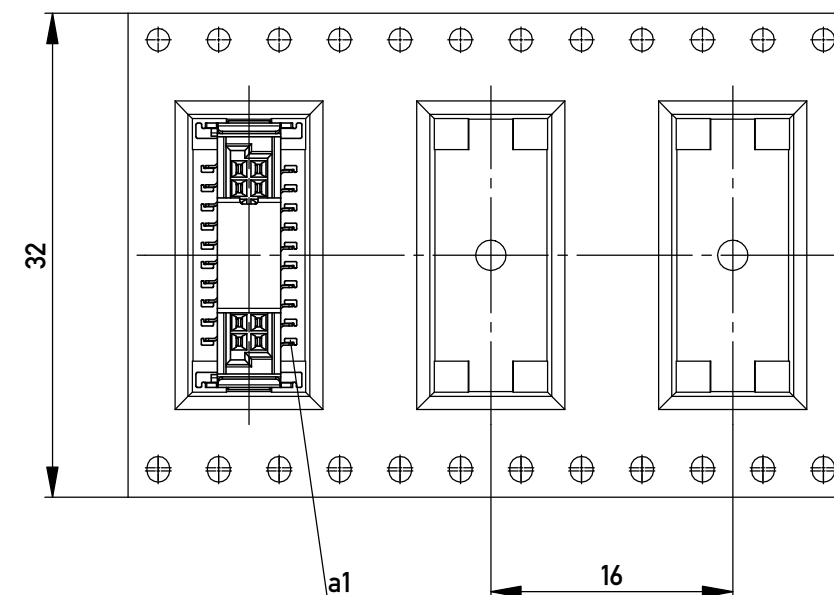
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs



Abspulrichtung - Reel off Direction

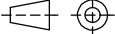


BA 7-13 - 8mm Bauhöhe

type7-13 - Low Profile

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Proprietary notice pursuant to ISO 10303-21:2015 to be observed.

Information:				Tolerances		 All Dimensions in mm		Scale 3:1					
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								Federl. SMC-B 20-SMD-BA7-13 <i>Female SMC-B 20-SMD-type7-13</i>					
								www.ERNI.com		100103210151			K
				c				19.07.2016				A3	
Index				Date				Class		SMCB			